Acid Etch

Introduction
The acid etch referred to in this technical bulletin is the process that North American architectural anodizers have been adopting since 2005. The chemistry is based on ammonium bifluoride combined with adjuncts to improve finish quality and reduce chemical consumption.

In general, etching aluminum provides several different features

- Removes ground in impurities
- Smooth out surface imperfections such as extrusion lines and mild scratches
- Removes ground in oxide and scale
- Produces a uniform smooth surface
- Changes the natural brightness to a dull matte finish

A conventional caustic etch creates relatively large pits that tend to follow aluminum grain boundaries, imperfections and inter-metallic particulates. It is a coarse etch that, by eating away enough aluminum reduces the gloss level to an acceptable value. To the contrary, an acid etch will produce a higher population of smaller, evenly dispersed pits, consuming far less aluminum. The difference in the appearance of the surface is depicted in the SEM pictures below:

Caustic Etched 6063 T-5 Panel  Acid Etched 6063 T-5 Panel
Benefits
Acid Etch produces a superior low gloss matte finish for hiding metal imperfections such as die lines, extrusion welds, and large grain “spangle”. It enables the anodizer to successfully process metal that could have been originally deemed as scrap and it improves line efficiency by reducing re-work. Compared to conventional caustic etch, 80-90% less aluminum needs to be removed from the surface to achieve the desired gloss. As a result, aluminum sludge volume is lessened, finished aluminum (selling) weight is increased, and rack life is improved.

Chemistry & Consumption
Ammonium bifluoride, being the active chemical, reacts with aluminum (etches) to produce aluminum fluoride, hydrogen gas, and due to the acidic nature of the bath, ammonium cat-ions. The pH of an acid etch is usually maintained at or near 5.0. The temperature is kept near 115°F, and the time, usually 2-5 minutes. The chemical reaction is as follows.

\[ 3\text{NH}_4\text{HF} + \text{Al} \rightarrow \text{AlF}_3 + \frac{1}{2} \text{H}_2 + 3\text{NH}_4^+ \]

Based on this equation, 27g aluminum requires 171g ammonium bifluoride to react with it. Considering the optimum weight loss for acid etched aluminum is 1.0-1.5 g/ft², it can be calculated that 6.3 – 9.5g ammonium bifluoride is theoretically needed to etch 1 square foot. This equates to 48-72 ft²/lb. This theoretical value has been found to be quite accurate in practice. Very little heat is generated by the reaction, and as a result cooling of the bath is not generally needed.

Aluminum fluoride is insoluble, so as it is produced it precipitates out of solution. When the agitation is turned off, the solids settle quickly and compactly. Solids are generally monitored by sampling the agitated bath and allowing the solids to settle in a graduated cylinder. A volume measurement is taken. The level of solids in the bath should be kept as low as possible and never allowed to exceed 10% by volume. Acid concentration can be measured by a simple acid/base titration, or by selective ion electrode, in this case fluoride.

Process & Production
With respect to etch defects, the acid etch is a relatively forgiving process. The few problems that are encountered are usually due to the acid content being too low (staining), or suspended solids being too high (pimpling). Since the bath is not viscous, there is no problem with rinsing, and because the etch period is generally only a few short minutes, production bottlenecks do not occur.

The finish produced by a stand-alone acid etch is generally too “chalky” in appearance, so in practice it is usually followed by a very brief (0.5-2 min) conventional caustic etch. The caustic etch brings back the natural metallic look that one associates with anodized aluminum.
Below is an example of the pretreatment portion of an anodize line set up for acid etching.

1. Clean
2. Rinse
3. Acid Etch (Times may vary from 2 to 5 minutes)
4. Rinse
5. Caustic Etch (Determined by desired finish)
6. Rinse
7. Rinse
8. Deoxidize
9. Rinse

**Materials & Equipment**

Due to the highly corrosive nature of acid fluoride solutions, metal in any form should not be designed to come into long-term contact with an acid etch. It is preferred that either plastic or plastic lining be used for process tanks, pumps, piping etc. The heating source, preferably Teflon® coated, should be designed to achieve a tank temperature of 120°F. Other requirements include a filter press and an exhaust system with scrubber.

**Environmental Health & Safety**

As with any chemical used on an anodize line, appropriate PPE including gloves, boots, apron and face shield should be used by individuals handling or otherwise potentially coming into bodily contact with acid etch. Due to the unusually large volume of chemical additions required to keep the chemistry within acceptable limits, additions made by hand directly to the tank can be tedious, time consuming and sometimes dangerous. As a result, a pumping system is generally set up between a premixing station and the tank.

The pH of post etch rinse tanks and waste treatment neutralization systems, if allowed to rise too high will result in the release of noxious ammonia fumes. Appropriate precautions should be taken.

The sludge generated by the process, although greatly reduced when compared to a conventional caustic etch process, must be removed and disposed of in a manner consistent with local and state agencies. Direct dischargers should also consider that nitrogen levels in their waste will be elevated and that equipment for remediation may be required by the local governing agencies.